TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOSVII)

TPCA8006-H

Switching Regulator Applications
Motor Drive Applications
DC / DC Converter Applications

- Small footprint due to a small and thin package
- High speed switching
- Low drain-source ON-resistance

: RDS (ON) = 41 m Ω (typ.) (VG=10V, ID=9A)

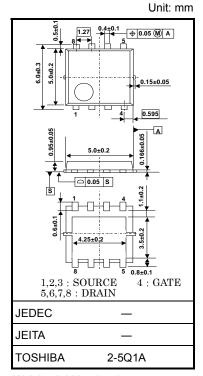
- High forward transfer admittance: $|Y_{fs}| = 15 S$ (typ.)
- Low leakage current: $I_{DSS} = 100 \,\mu\text{A} \,(\text{max}) \,(V_{DS} = 100 \,\text{V})$
- Enhancement mode: $V_{th} = 3.0 \text{ to } 5.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characte	eristic	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	100	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	100	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	18	А	
Diain current	Pulsed (Note 1)	I _{DP}	36		
Drain power dissipati	on (Tc=25°C)	PD	45	W	
Drain power dissipation (t = 10 s) (Note 2a)		P_{D}	2.8	W	
Drain power dissipation $(t = 10 s)$ (Note 2b)		P _D	1.6	W	
Single-pulse avalanche energy (Note 3)		E _{AS}	224	mJ	
Avalanche current		I _{AR}	18	Α	
Repetitive avalanche energy (Note 2a) (Note 4)		E _{AR}	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	−55 to 150	°C	

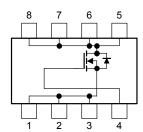
Note: For Notes 1 to 4, refer to the next page.

This transistor is an electrostatic-sensitive device. Handle with care.



Weight: 0.069 g (typ.)

Circuit Configuration

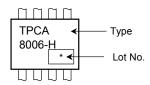




Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R _{th (ch-a)}	78.1	°C/W

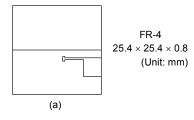
Marking (Note 5)

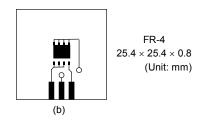


Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)

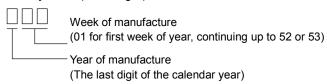




Note 3: $V_{DD} = 50 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.8 mH, $R_G = 25 \Omega$, $I_{AR} = 18 \text{ A}$

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: * Weekly code: (Three digits)

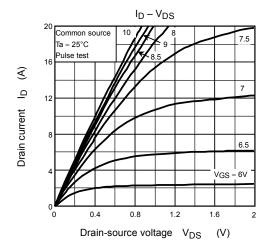


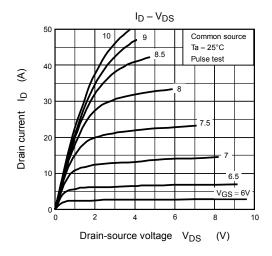
Electrical Characteristics (Ta = 25°C)

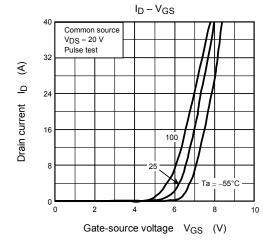
Ch	naracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rrent	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cutoff curre	ain cutoff current		V _{DS} = 100 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source bre	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	100	_	_	V
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	3.0	_	5.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 9 A	_	41	67	mΩ
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 9 A	7.5	15	_	S
Input capacitance		C _{iss}			780	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		17	_	
Output capacitance		Coss		_	390	_	
Switching time	Rise time	t _r	Acs 0 A 10 A 10 = 8 4 A 10 A	_	3	_	- ns
	Turn-on time	t _{on}		_	13	_	
	Fall time	t _f		_	2	_	
	Turn-off time	t _{off}	$V_{DD} \simeq 50 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	13	_	
Total gate charge (gate-source plus gate-drain)		Qg			12	_	nC
Gate-source charge 1		Q _{gs1}	$V_{DD} \simeq 80 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 18 \text{ A}$		5.6		
Gate-drain ("Miller") charge		Q _{gd}		_	4.0	_	
Gate switch charge		Q _{SW}]	_	6.9	_	

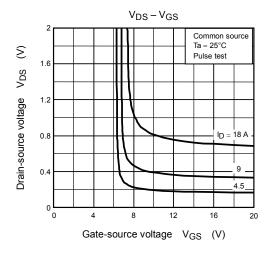
Source-Drain Ratings and Characteristics (Ta = 25°C)

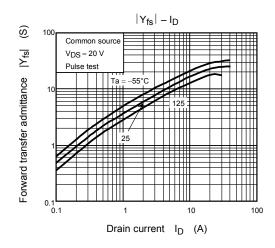
Character	istic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	I _{DRP}	_	_	_	36	Α
Forward voltage (diode)		V _{DSF}	I _{DR} = 18 A, V _{GS} = 0 V	_	_	-1.7	V

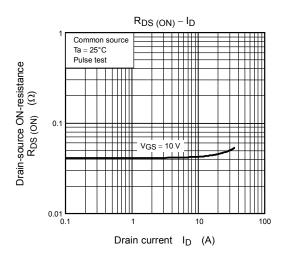


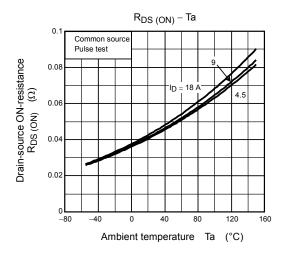


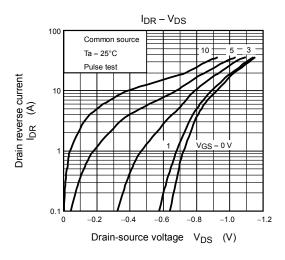


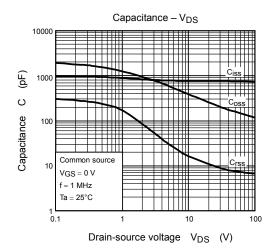


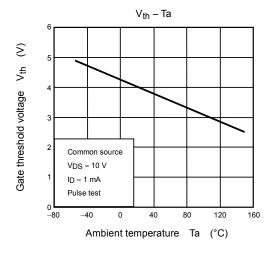


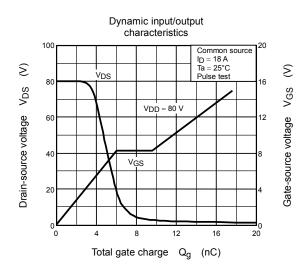


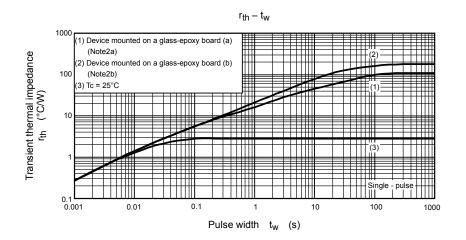


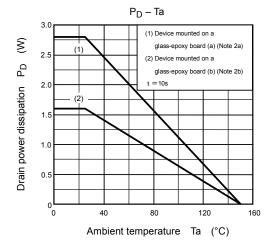


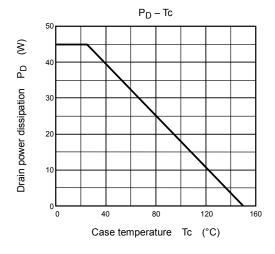


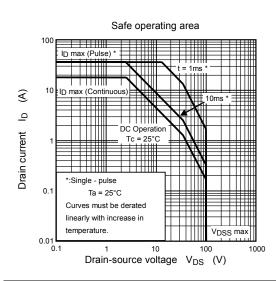












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